

Applications of Digital Signal Processing for Energy Dispersive X-Rays Detectors

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Agenda

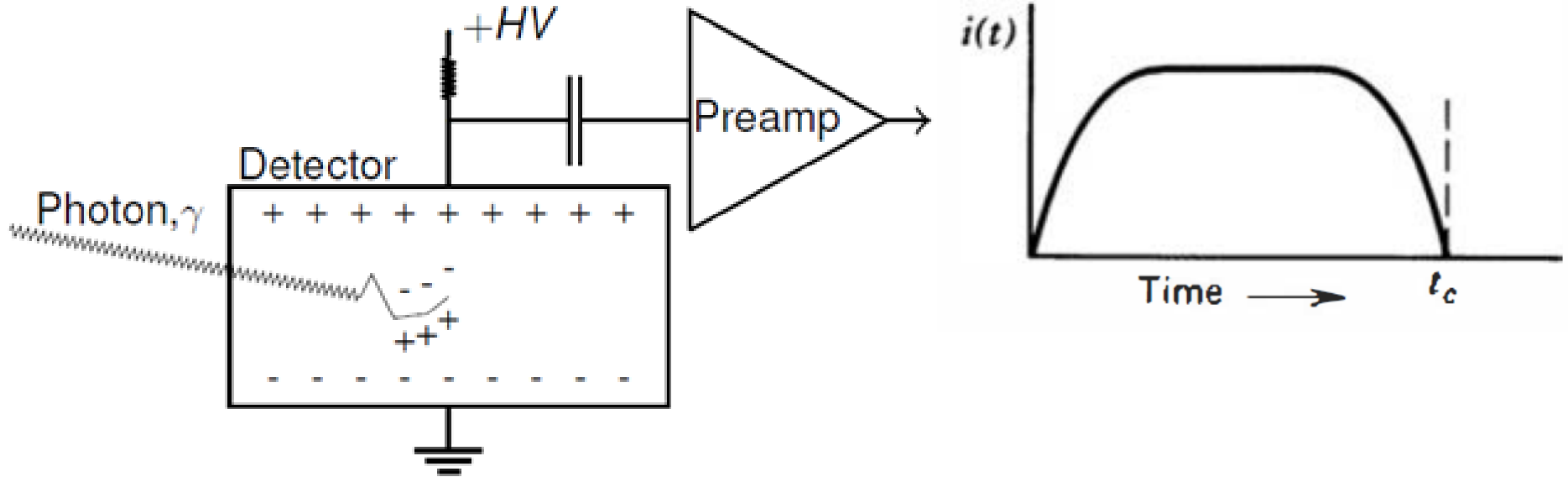
1. Introduction
2. Digital Signal Processing
3. Hardware
4. Market Analysis
5. Conclusion

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Introduction



Introduction



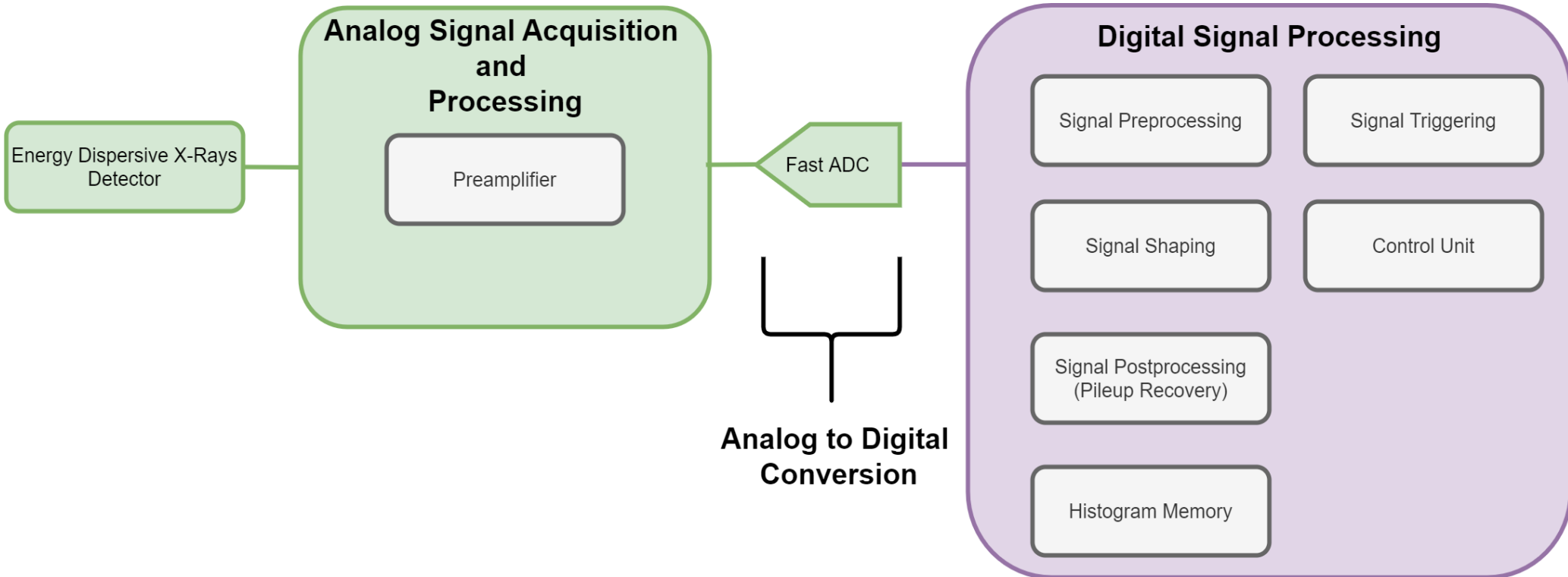
- Detector
Solid State detectors
(Semiconductor)

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Digital Signal Processing



Block Diagram





Digital Signal Processing Algorithms

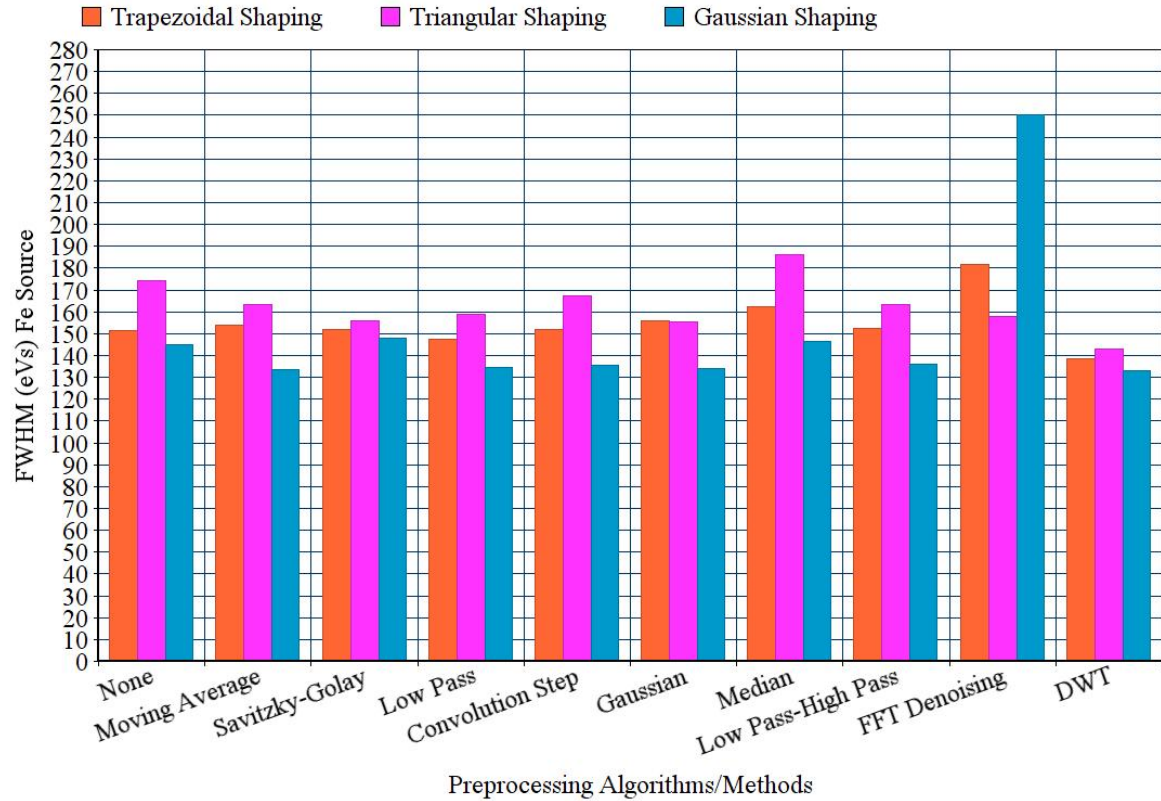
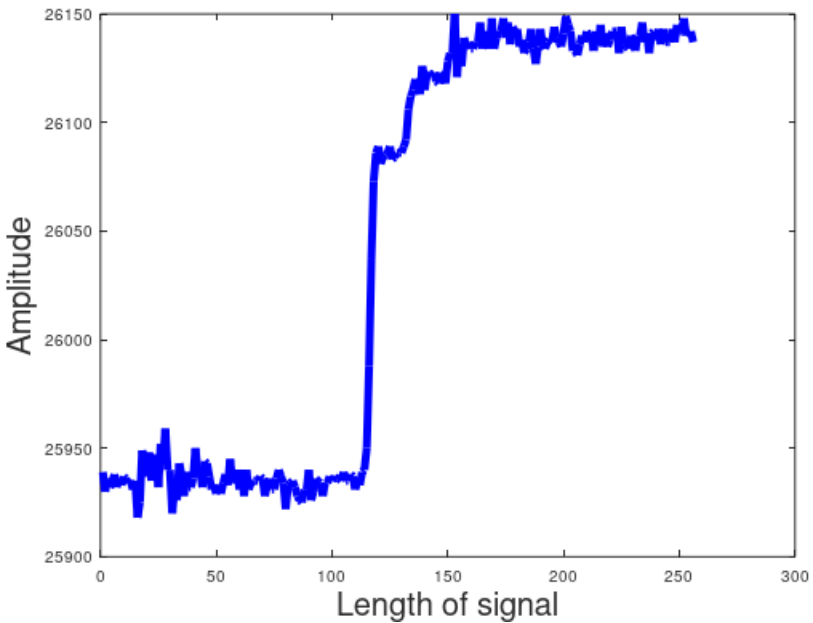
- ◉ Signal Preprocessing
- ◉ Signal Shaping
- ◉ PileUp Recovery and Rejection

- ◉ **Signal Preprocessing Methods**
 - 1) Moving Average Filter
 - 2) Savitzky-Golay Filter
 - 3) Gaussian Smoothing Filter
 - 4) Independent Component Analysis (ICA)
 - 5) Discrete Wavelet Transform (DWT)

- ◉ **Signal Shaping Methods**
 - 1) Trapezoidal Filter
 - 2) Triangular Filter
 - 3) Cusp Filter
 - 4) Flat Top Cusp Filter
 - 5) Gaussian Filter

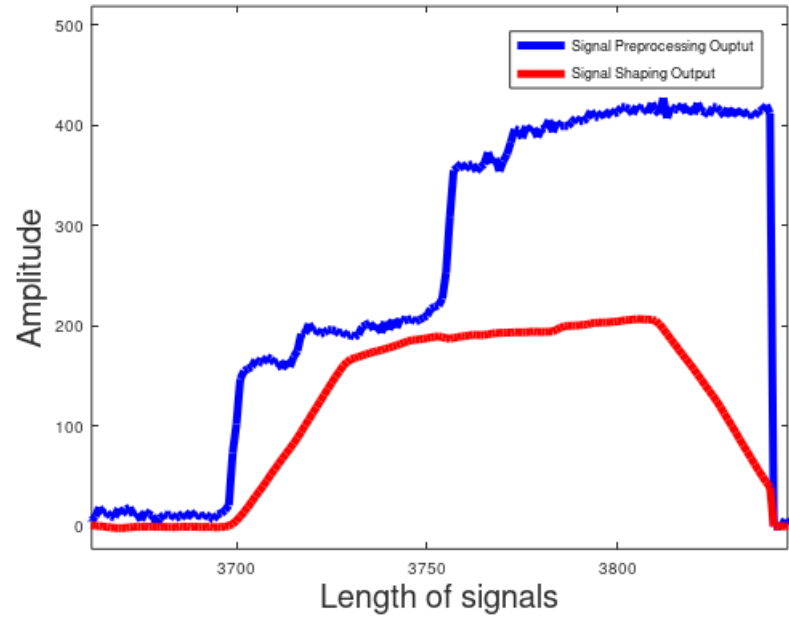
- ◉ **PileUp Recovery and Rejection Methods**
 - 1) Deconvolution
 - 2) Linear Discriminant Analysis (LDA)
 - 3) Artificial Neural Network (ANN)
 - 4) Support Vector Machine (SVM)

Input ADC Raw Data

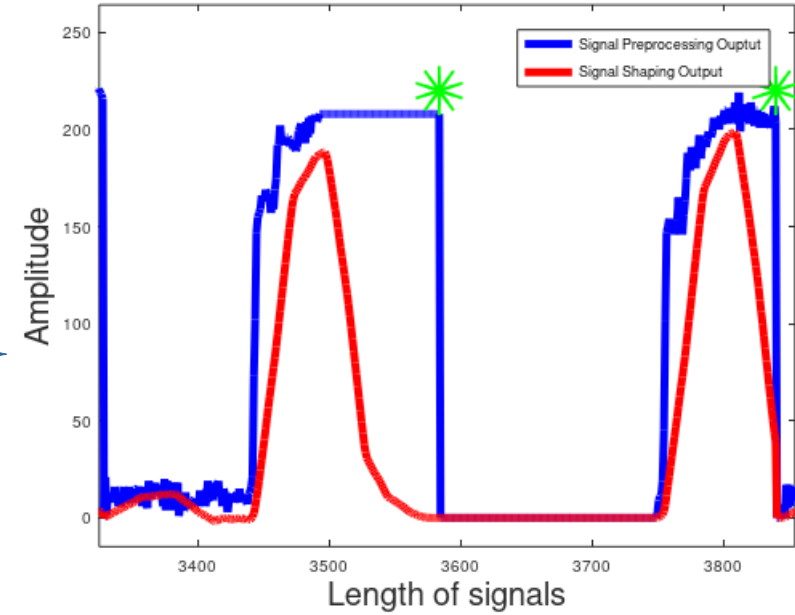


- Tested with real ADC data from samples at the beamline (P24).
- Trapezoidal filter gives highest energy resolution but at higher count rates pile up increases due to longer shaping times, while triangular filter gives low energy resolution but pile up decreases for higher count rates due to shorter shaping times.
- Maximum achievable energy resolution is 100-155 eV for Fe source at 5.9 KeV at 0.650 microseconds peaking time.
- Highest flexibility for the User to select between different algorithms/methods for best possible energy resolution.

Pileup Analysis



Pileup Analysis



- Signal Postprocessing (Pile Up Recovery Unit) for Higher count rates.
- Multiple algorithms for pile up correction.
- Highest flexibility for the User to select between different algorithms/methods for best possible pileup detection and correction to achieve higher count rates.

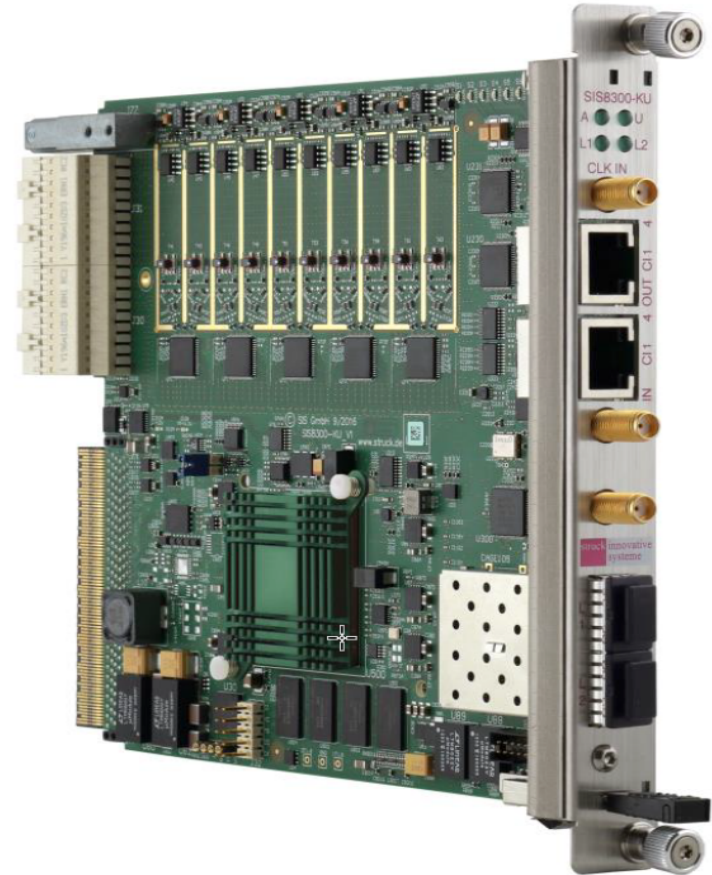
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Hardware



Hardware

- SIS8300-KU MTCA.4 Digitizer
- 10 channel 125 MS/s digitizer with 16-bit resolution
- FPGA Xilinx Kintex Ultrascale
- AMC .4 μ TCA for Physics Board
- 4 Lane PCI Express Gen3 Interface





QT Based GUI

QtHardMon@hase026mtca

File Plugins Settings Help

<< Devices:

- KU
- L

Device status

Device is open. Close

Device properties

Device name: KU

Device identifier: sdm://./pci:pcieunis2;

Map file: gamma_sis8300ku.mapp

Load Boards

Modules/Registers:

- AREA_SPI_ADC
- WORD_DAC_ENA
- WORD_DAC_IDELAY_INC
- WORD_DAC_IDELAY_CNT
- AREA_BOOT
- WORD_RJ45_IN
- WORD_RJ45_OUT
- WORD_MIG_INIT_DONE
- AREA_DMA
- FCM
 - AREA_WRITE
 - AREA_READ
 - WORD_SPI_DIVIDER
 - WORD_BYTES_TO_WRITE
 - WORD_BYTES_TO_READ
 - WORD_CONTROL
 - WORD_TCK
 - WORD_TMS
 - WORD_TDI
 - WORD_TDO
 - WORD_MAGIC
 - WORD_REV_SWITCH
 - WORD_REV_SEL
 - WORD_CRC_ERROR
 - WORD_CRC_ERROR_CNT
 - WORD_ECC_ERROR_CNT
 - WORD_ECC_SYNDROME
- APP
 - WORD_APP ID**
 - WORD_APP_STATUS
 - WORD_APP_TEST_REG_READ
 - WORD_APP_TEST_REG_WRITE

Sort Modules/Registers

Autoselect previous register

Register properties

Register path: /APP/WORD_APP_ID

Dimension: Scalar

Data Type: Unsigned integer

Numerical Address	Fixed Point Interpretation
Bar: 1	Register width: 32
Address: 0	Fractional bits: 0
Total size (bytes): 4	Signed Flag: 0

Values

	Value	Raw (dec)	Raw (hex)
0	196610	196610	0x30002

Options

Continuous read

Read after write

Show plot window


Operations

Read

Write

Write to file

Read from file



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Market Analysis



Market Analysis

Company	FWHM (eV)	Peaking Time (microsecs)
Amptek FASTSDD Detectors	122	4
Vortex ME4 Detectors	145-155	1
Vitus	126	1
Mirion Technologies	145	0.650
This Work	100-155	0.650

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Conclusion



Conclusion

- ⦿ Improved Data Analysis Algorithms for Energy Dispersive X-Rays Detectors
- ⦿ Reduced huge amount of data transfer through PCIE as only the spectrum is transferred
- ⦿ Improved PileUp Events (PileUp Correction)
- ⦿ Increased Photon Counts
- ⦿ Improved Energy Resolution (FWHM 100-155 eVs) at shorter shaping times (0.625 microseconds)
- ⦿ Real Time Data Analysis (On-the-Fly Scanning)
- ⦿ Application firmware was embedded in the MSK board support package
- ⦿ Qt based GUI for data acquisition, data analysis algorithms selection, parameter adjustment and debugging



Source

- Amptek:
<https://www.amptek.com/products/x-ray-detectors/fastssdd-x-ray-detectors-for-xrf-eds/fastssdd-silicon-drift-detector>
- Vortex ME4 X-Ray Detector
https://www.hitachi-hightech.com/hhs-us/product_detail/?pn=ana-vortex-me4
- Vitus
<https://www.ketek.net/sdd/vitus-sdd-modules/>
- Quantum Detectors
<https://quantumdetectors.com/>
- SXD15M-150-500-TO8 Silicon Drift Detector SDD
<https://www.mirion.com/products/sxd15m-150-500-to8-silicon-drift-detector-sdd>



Source

- Struck innovative systeme:

<https://www.struck.de/>

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Thanks!

Any questions ?

You can find me at

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